

Part Number: WP483SRSGW

Super Bright Red
Super Bright Green

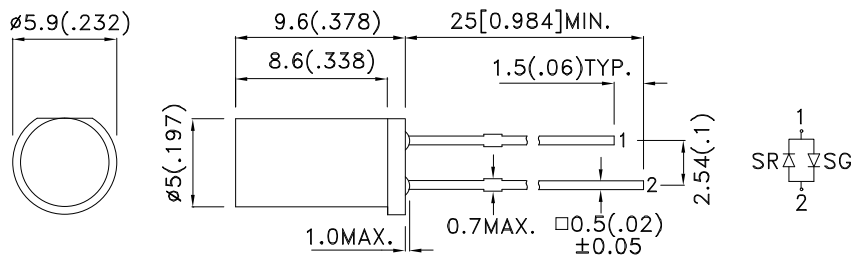
Features

- CYLINDRICAL TYPE, TOP DIFFUSED.
- I.C. COMPATIBLE.
- LOW POWER CONSUMPTION.
- RELIABLE AND RUGGED.
- LONG LIFE-SOLID STATE RELIABILITY.
- AVAILABLE ON TAPE AND REEL.
- RoHS COMPLIANT.

Description

The Super Bright Red source color devices are made with Gallium Aluminum Arsenide Red Light Emitting Diode.
The Super Bright Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25 (0.01)$ unless otherwise noted.
3. Lead spacing is measured where the leads emerge from the package.
4. Specifications are subject to change without notice.



Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Typ.	2θ1/2
WP483SRSGW	Super Bright Red (GaAlAs)	WHITE DIFFUSED	18	50	80°
	Super Bright Green (GaP)		4	10	

Notes:

- θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
- Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λ _{peak}	Peak Wavelength	Super Bright Red Super Bright Green	660 565		nm	I _F =20mA
λ _D [1]	Dominant Wavelength	Super Bright Red Super Bright Green	640 568		nm	I _F =20mA
Δλ _{1/2}	Spectral Line Half-width	Super Bright Red Super Bright Green	20 30		nm	I _F =20mA
C	Capacitance	Super Bright Red Super Bright Green	45 15		pF	V _F =0V;f=1MHz
V _F [2]	Forward Voltage	Super Bright Red Super Bright Green	1.85 2.2	2.5 2.5	V	I _F =20mA

Notes:

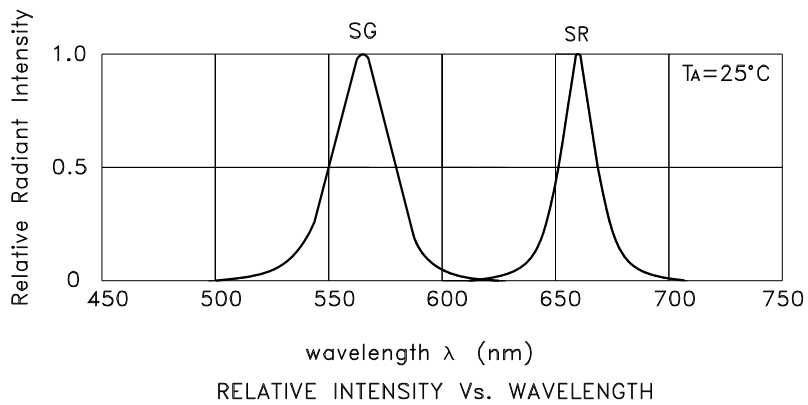
- Wavelength: +/-1nm.
- Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

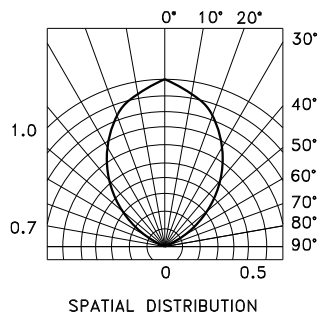
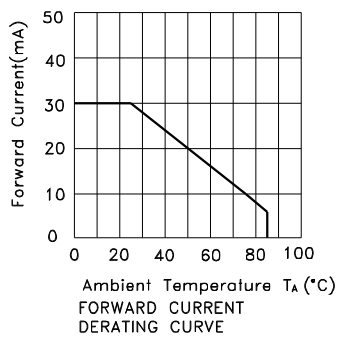
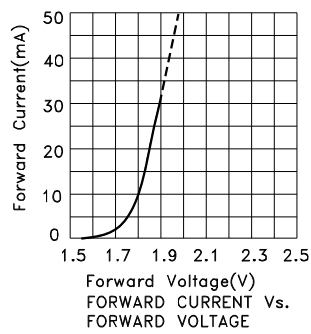
Parameter	Super Bright Red	Super Bright Green	Units
Power dissipation	75	62.5	mW
DC Forward Current	30	25	mA
Peak Forward Current [1]	155	140	mA
Operating / Storage Temperature	-40°C To +85°C		
Lead Solder Temperature [2]	260°C For 3 Seconds		
Lead Solder Temperature [3]	260°C For 5 Seconds		

Notes:

- 1/10 Duty Cycle, 0.1ms Pulse Width.
- 2mm below package base.
- 5mm below package base.

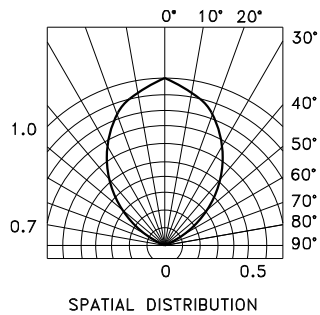
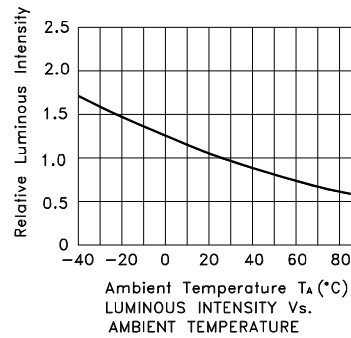
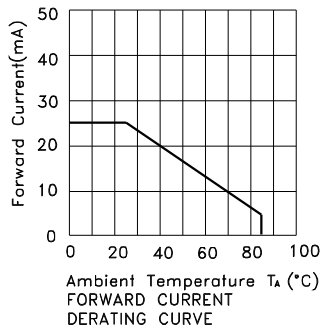
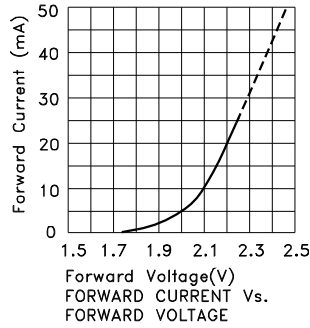


WP483SRSGW Super Bright Red



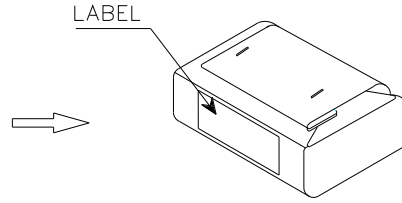
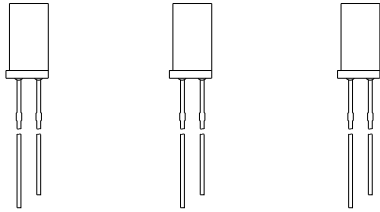
Kingbright

Super Bright Green

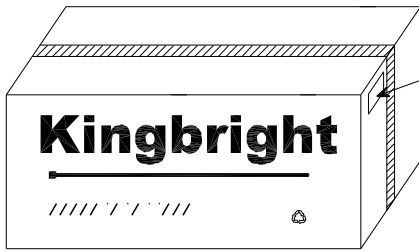


PACKING & LABEL SPECIFICATIONS

WP483SRSGW

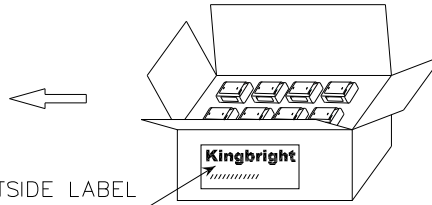


500 PCS/BAG



32K/9# BOX

OUTSIDE LABEL



OUTSIDE LABEL

16K/5# BOX

<h1 style="margin: 0;">Kingbright</h1>	
Q.C.	<div style="border: 1px solid black; border-radius: 50%; padding: 5px; display: inline-block;"> QC XXX XX. XXXX PASSED </div>
TYPE NO : WP483XXX	
QUANTITY : 500 pcs	
S/N : XXX	CODE: XXXX
LOT NO :	 xx-xxxxx
RoHS Compliant	

LED MOUNTING METHOD

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures.

(Fig. 1)

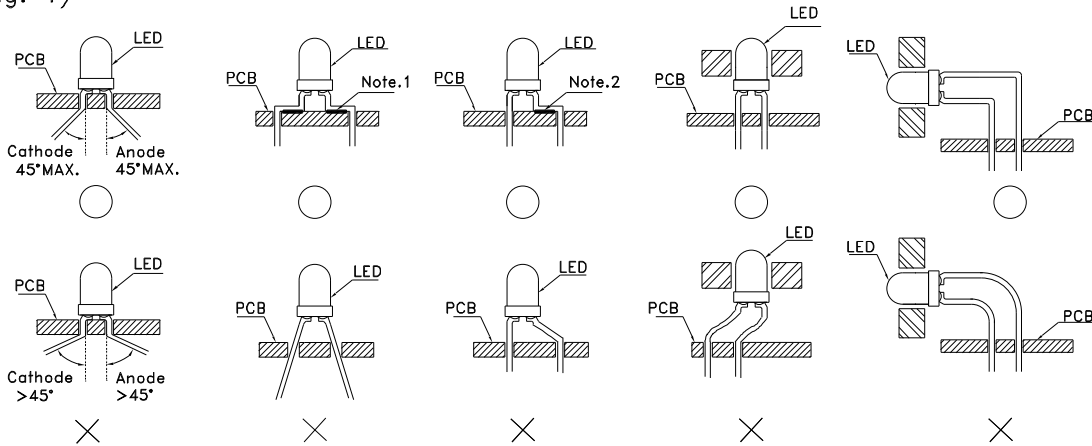


Fig.1

“○” Correct mounting method “X” Incorrect mounting method

Note 1-2 : Do not route PCB trace in the contact area between the leadframe and the PCB to prevent short-circuits.

2. When soldering wire to the LED, use individual heat-shrink tubing to insulate the exposed leads to prevent accidental contact short-circuit.

(Fig. 2)

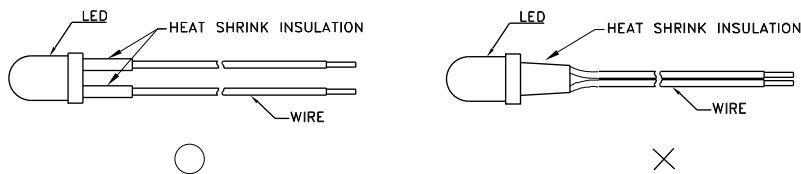


Fig. 2

3. Use stand-offs (Fig. 3) or spacers (Fig. 4) to securely position the LED above the PCB.

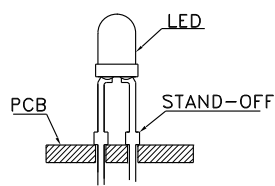


Fig. 3

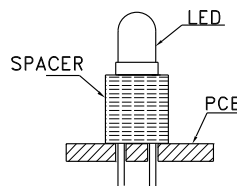


Fig. 4

LEAD FORMING PROCEDURES

1. Maintain a minimum of 2mm clearance between the base of the LED lens and the first lead bend. (Fig. 5 and 6)

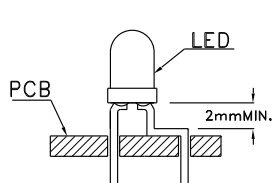


Fig. 5

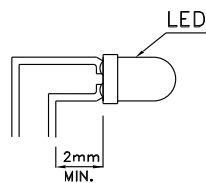


Fig. 6

2. Lead forming or bending must be performed before soldering, never during or after Soldering.
3. Do not stress the LED lens during lead-forming in order to fractures in the lens epoxy and damage the internal structures.
4. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 7)
5. Do not bend the leads more than twice. (Fig. 8)

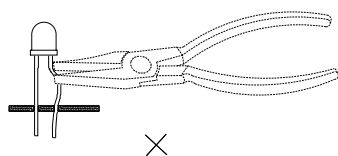


Fig. 7

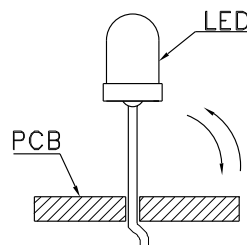


Fig. 8

6. After soldering or other high-temperature assembly, allow the LED to cool down to 50°C before applying outside force (Fig. 9). In general, avoid placing excess force on the LED to avoid damage. For any questions please consult with Kingbright representative for proper handling procedures.

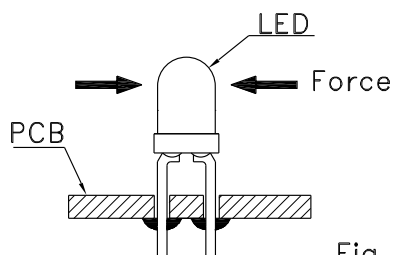


Fig. 9

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

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- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

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Конструкторский отдел помогает осуществить:

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- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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